



SURFACE MOUNT FAST SWITCHING DIODE

Features

- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- Dual Isolated Device with Opposing Polarity
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOT-563
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Lead-Frame; Solderable per MIL-STD-202, Method 208 (c3)
- Weight: 0.003 grams (Approximate)



Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
MMBD4448V-7	Standard	SOT-563	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

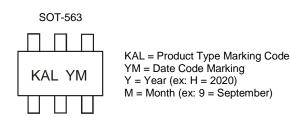
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Notes:

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/...

Marking Information (Note 5)



Date Code Key												
Year	2004			2020	2021	20	22	2023	2024	20)25	2026
Code	R			Н	I		J	K	L	١	N	Ν
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Notes: 5. Package is non-polarized. Parts may be on reel in orientation illustrated, 180° rotated, or mixed.



Maximum Ratings (@ $T_A = +25^{\circ}C$ unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current (Note 6)		I _{FM}	500	mA
Average Rectified Output Current (Note 6)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I _{FSM}	4.0 1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	150	mW
Thermal Resistance Junction to Ambient (Note 6)	R _{0JA}	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

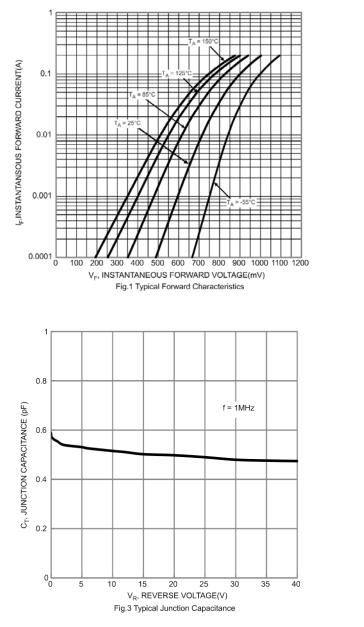
Electrical Characteristics (@ T_A = +25°C unless otherwise specified.)

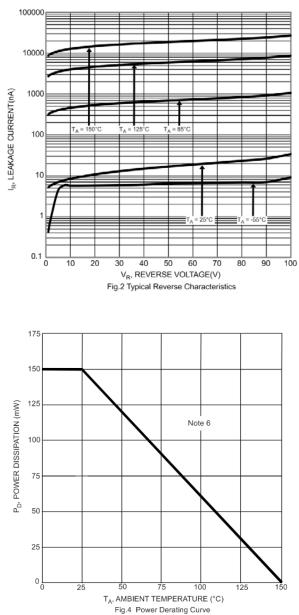
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	80		V	$I_R = 2.5 \mu A$
		0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage	VF	—	0.855		$I_F = 10 \text{mA}$
Torward voltage	٧F	_	1.0		$I_F = 100 \text{mA}$
		_	1.25		I _F = 150mA
			100	nA	V _R = 70V
Leakage Current (Note 7)	1-		50	μA	V _R = 75V, T _J = +150°C
Leakage Current (Note 7)	IR		30	μA	V _R = 25V, T _J = +150°C
			25	nA	$V_R = 20V$
Total Capacitance	CT	_	3.5	pF	$V_{R} = 6V, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	—	4.0	ns	$I_F = I_R = 10 \text{mA},$
	٩r				$I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

6. Device mounted on FR-4 PCB, 1-inch x 0.85 inch x 0.062 inch pad layout. 7. Short duration pulse test used to minimize self-heating effect. Notes:

MMBD4448V



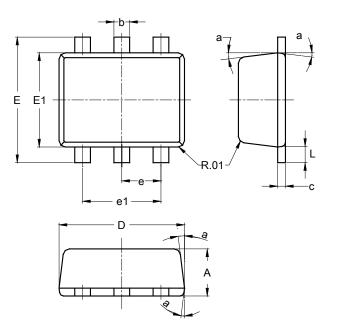






Package Outline Dimensions

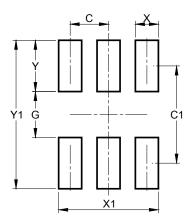
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT563						
Dim	Min	Max	Тур			
Α	0.55	0.60	0.60			
b	0.15	0.30	0.20			
c	0.10	0.18	0.11			
D	1.50	1.70	1.60			
ш	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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